



Technical Specification for Optical Transceiver Module

SCM6328

- | | | |
|---|---|--|
| <input type="checkbox"/> 155.52Mbps | <input type="checkbox"/> 622.08Mbps | <input checked="" type="checkbox"/> other 2488.32Mbps |
| <input type="checkbox"/> Short Haul | <input type="checkbox"/> Long Haul | <input checked="" type="checkbox"/> other Intra office |
| <input type="checkbox"/> Intermediate Reach | <input type="checkbox"/> Long Reach | <input checked="" type="checkbox"/> other Short Reach |
| <input type="checkbox"/> Single 5.0 V | <input checked="" type="checkbox"/> Single 3.3 V | <input type="checkbox"/> other _____ |
| <input checked="" type="checkbox"/> 1.3 μ m | <input type="checkbox"/> 1.55 μ m | <input type="checkbox"/> other _____ |
| <input type="checkbox"/> Transmitter | <input type="checkbox"/> Receiver | <input checked="" type="checkbox"/> Transceiver(2 X 10) |
| | (<input type="checkbox"/> 2R / <input type="checkbox"/> 3R) | (<input checked="" type="checkbox"/> 2R / <input type="checkbox"/> 3R) |

Applicable Part Numbers : SCM6328-GL-ZN, SCM6328-GL-CN, SCM6328-GL-DN

SCM6328-GL-ZW, SCM6328-GL-CW, SCM6328-GL-DW




Sumitomo Electric reserves the right to make changes in this specification without prior notice.

#Safety Precaution Symbols This specification uses various picture symbols to prevent possible injury to operator or other persons or damage to properties for appropriate use of the product. The symbols and definitions are as shown below. Be sure to be familiar with these symbols before reading this specification.

Warning Wrong operation without following this instruction may lead to human death or serious injury.

Caution Wrong operation without following this instruction may lead to human injury or property damage.

Example of picture symbols  indicates prohibition of actions. Action details are explained thereafter.

 indicates compulsory actions or instructions. Action details are explained thereafter.

1. General

Features and applications of SCM6328 are listed below.

Features

* Multi Bit Rate Operation	155Mbps ~ 2.5Gbps
* Power Supply Voltage	Single +3.3V
* Compact Package Size	49.0 X 13.59 X 9.8 mm (max.)
* Electrical Interface	AC for DATA and LVTTTL for Signal Detect and Laser Disable
* Fiber Coupled Power	-3 ~ -10dBm into SMF
* Input Power Range	-3 ~ -18dBm
* Monitor Functions	Laser Bias Monitor, Rear Facet Monitor
* Laser Disable Function	
* Signal Detect (SD) Function	
* Connector Interface	LC Duplex Connector

Applications

*Telecommunications	*Data communications
> SONET/SR, SDH/IO Application	>High Speed Rack-to-Rack Data Links
> ATM Application	
> Shelf-to-Shelf Multi Bit Rate Application	
> Subscriber Loop	
> Metropolitan Area Network	

2. Block Diagram

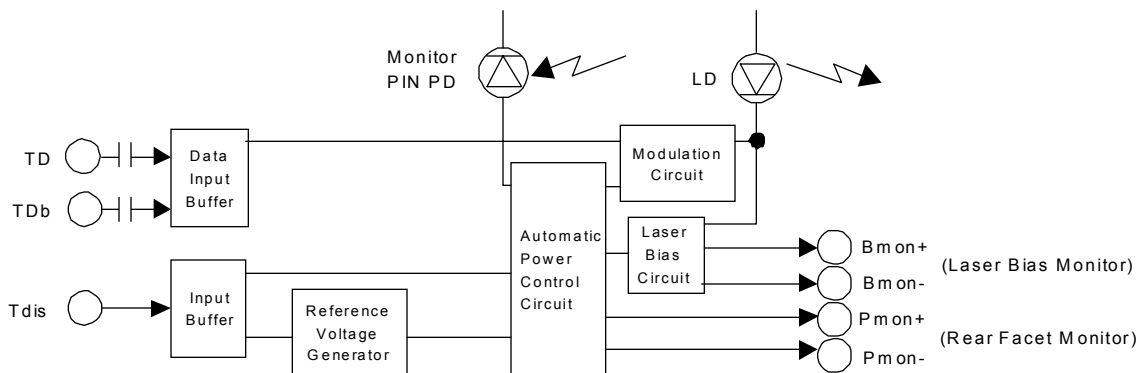


Figure 1. Block Diagram (Transmitter)

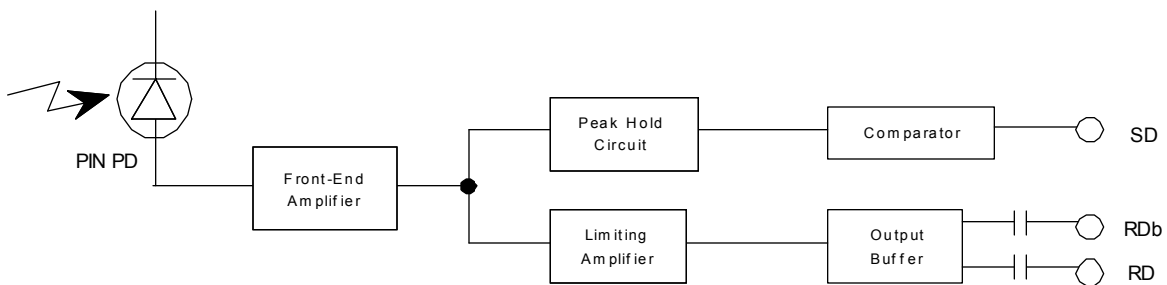


Figure 2. Block Diagram (Receiver)

⚠ Caution



Do not disassemble this product. Otherwise, failure, electrical shock, overheating or fire may occur.

Handle the lead pins carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body.

3. Package Dimension

3.1 SCM6328-GL-Z#

All dimensions are in mm.

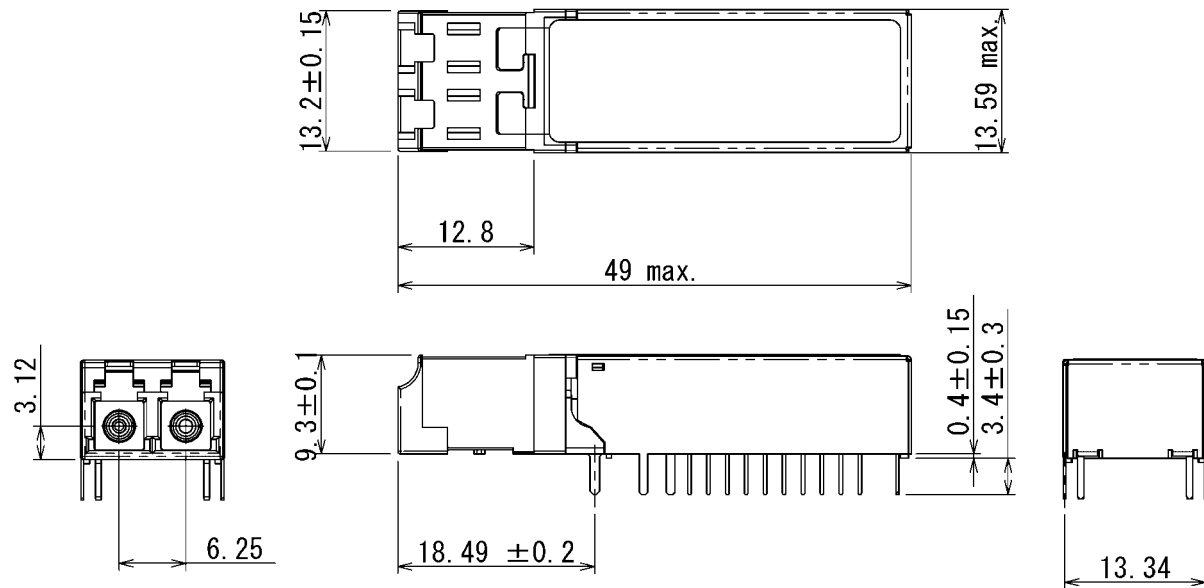


Figure 3. Outline Dimensions (SCM6328-GL-ZN)

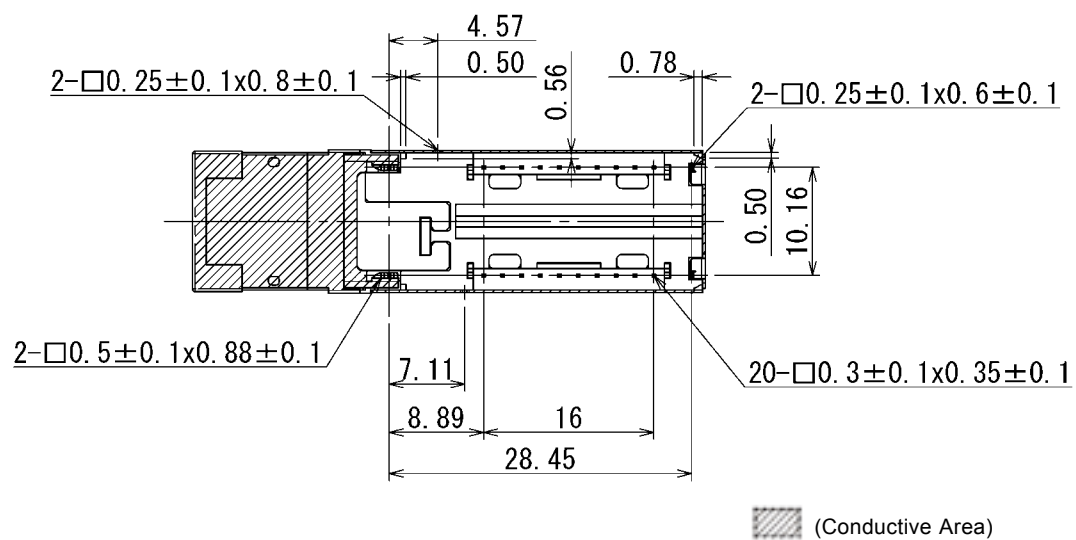
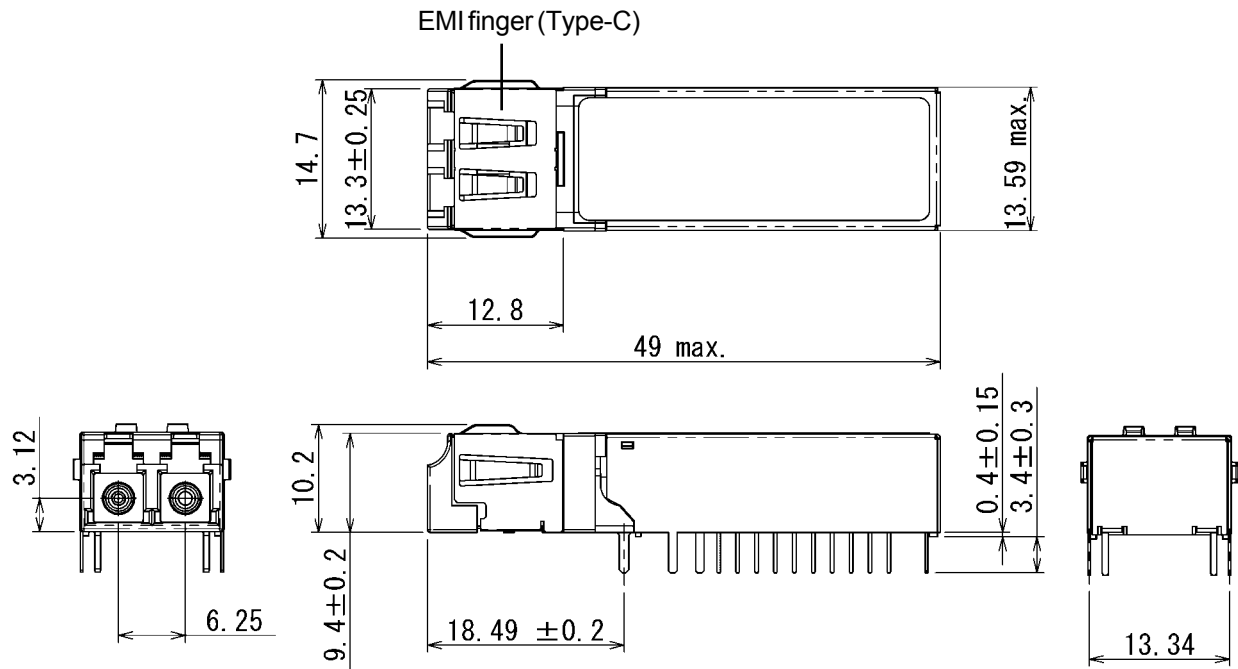


Figure 4. Bottom Side (SCM6328-GL-ZN)

3.2 SCM6328-GL-C#

All dimensions are in mm.



Type-C EMI finger is an option for transceivers to be used on the card-edge with the receptacle protruding through a panel opening. It has fingers on three sides to make electrical contact with the sides of the bezel opening for grounding purpose.

Figure 5. Outline Dimensions (SCM6328-GL-CN)

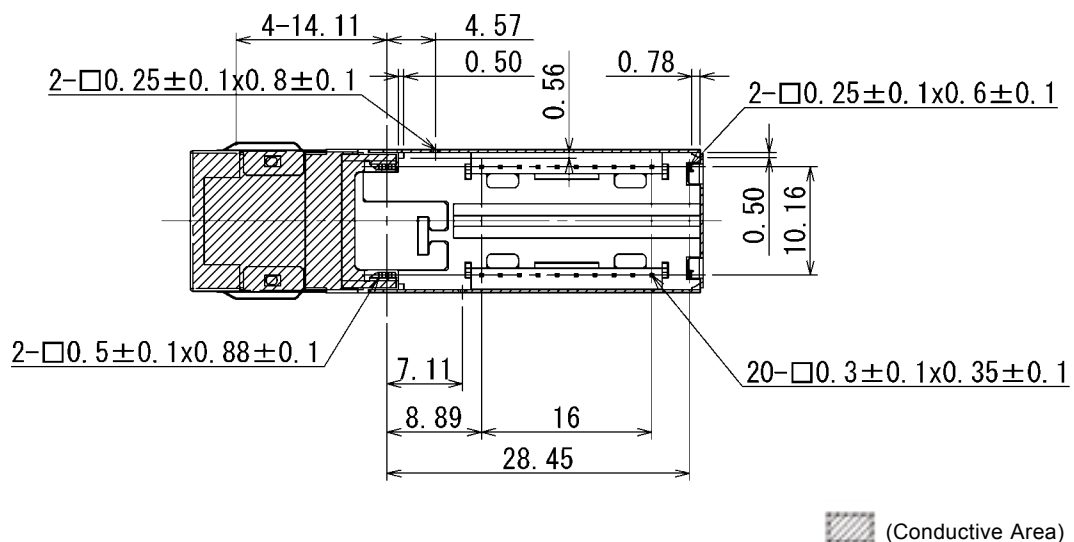
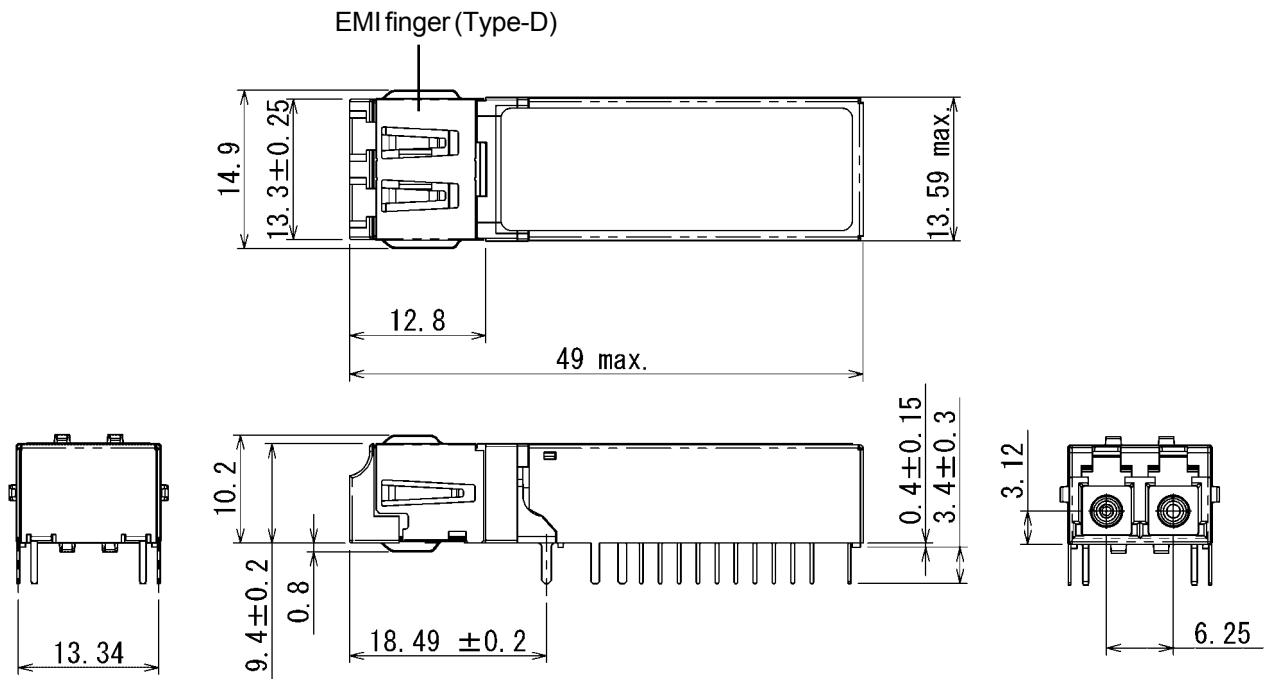


Figure 6. Bottom Side (SCM6328-GL-CN)

3.3 SCM6328-GL-D#

All dimensions are in mm.



Type-D EMI finger is an option for transceivers to be used on the card-edge with the receptacle protruding through a panel opening. It has fingers on four sides to make electrical contact with the sides of the bezel opening for grounding purpose.

Figure 7. Outline Dimensions (SCM6328-GL-DN)

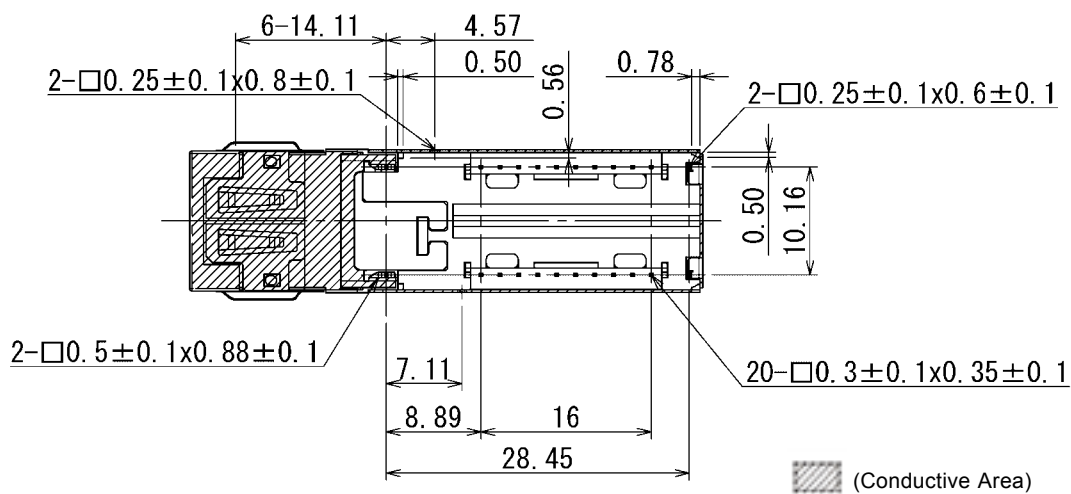


Figure 8. Bottom Side (SCM6328-GL-DN)



4. Pin Assignment

No.	Symbol	I/O/P	Level	Description
1	VpdR	P	+3.3V DC	DC Bias Supply for Receiver PIN-PD. Must be tied to Vcc.
2	VeeR	P	GND	Power Supply (-) for Receiver.
3	VeeR	P	GND	Power Supply (-) for Receiver.
4	NC			No User Connection.
5	NC			No User Connection.
6	VeeR	P	GND	Power Supply (-) for Receiver.
7	VccR	P	+3.3V DC	Power Supply (+) for Receiver.
8	SD	O	LV TTL	Signal Detect. High level indicates presence of optical input signal (Active High).
9	RDb	O	AC	Inverted Receiver Output Data. Internally AC Coupled and biased LVPECL.
10	RD	O	AC	Non-Inverted Receiver Output Data. Internally AC Coupled and biased LVPECL.
11	VccT	P	+3.3V DC	Power Supply (+) for Transmitter.
12	VeeT	P	GND	Power Supply (-) for Transmitter.
13	Tdis	I	LV TTL/LVCMOS	Transmitter Disable (Active High). Defaults to logic 0 (enable TX) when left open.
14	TD	I	AC	Non-Inverted Transmitter Input Data. Internally AC Coupled and 100Ohm (Differential) terminated input.
15	TDb	I	AC	Inverted Transmitter Input Data. Internally AC Coupled and 100Ohm (Differential) terminated input.
16	VeeT	P	GND	Power Supply (-) for Transmitter.
17	Bmon-	O	Analog Voltage	LD Bias Current Monitor. Voltage difference between pins 17 and 18 is proportional to the laser bias current.
18	Bmon+	O		
19	Pmon-	O	Analog Voltage	Rear Facet Monitor. Transmitter output power can be monitored, in terms of rear facet monitor PD current, by measuring voltage difference between pins 19 and 20.
20	Pmon+	O		

Notes:

1. I/O/P stand for signal input, signal output, and DC power/bias supply, respectively.
2. Refer to figure 13 for details of Bmon and Pmon outputs.

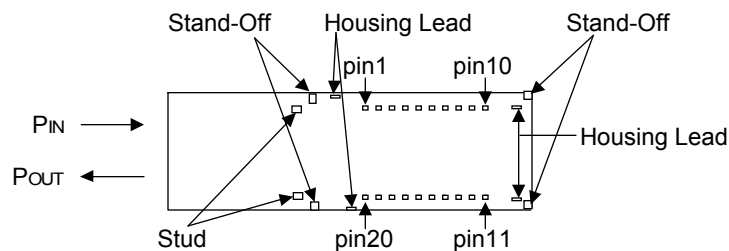


Figure 11. Bottom View

- * Mounting Studs are provided for mechanical support to the circuit board.
- It is recommended that the holes in the circuit board be connected to frame ground.
- * Stand-Offs provide gap between the circuit board and the module to help escape residual water after aqueous wash.

5. Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Storage Case Temperature	Ts	-40	-	85	°C	1
Operating Case Temperature	Tc	-5	-	70	°C	2, 6
		-40		85		3, 6
Supply Voltage	Vcc	0.0	-	4.0	V	
PIN-PD Bias Voltage	VpdR	-	-	7.0	V	
Input Voltage	Vi	0	-	Vcc+0.5	V	4
Lead Soldering	Temperature	Ltemp		260	°C	5
	Time	Ltime		10	sec.	

Notes

1. No condensation allowed.
2. SCM6328-GL-#N
3. SCM6328-GL-#W ; 1m/s air flow recommended
4. Tdis
5. Measured on lead pin at 2mm (0.079in.) off the package bottom
6. Refer to Section 9-2 for Tc definition.

⚠ Warning

- ⚠ Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

⚠ Caution

- ⚠ Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

6. Electrical Interface

(Unless otherwise specified, Vcc = 3.135 to 3.465 V and all operating temperature shall apply.)

6-1. Transmitter side

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Supply Voltage	Vcc	3.135	3.30	3.465	V	
Supply Current	Idtx		95	200	mA	1, 2
Differential Input Voltage Swing (TD,TDb)	Vin	0.4		2.00	Vp-p	3
Signal Input Rise/Fall Time	tr / tf			120	psec	4
Tdis Input Voltage	High	Vdi	2.0	Vcc	V	5
	Low	Veil	0.0	0.8	V	
Turn-on Time	ton			1	ms	6
Turn-off Time	toff			10	μs	6
LD Bias Monitor Voltage	Vbm	10		500	mV	1, 7
Rear Facet Monitor Voltage	Vrfm	10		200	mV	1, 7

Notes

- 50% duty cycle data.
- 2488.32Mbps
- Refer to Figure 14.
- 20 ~ 80%
- LVTTTL input. Refer to Section 8, "Relation between Disable Input Voltage and Optical Output Power", for detail.
- Refer to Figure 12.
- The Laser Bias Monitor Current and Rear Facet Monitor Current are calculated as ratios between the corresponding voltages and current sensing resistors, 200Ω, as shown in the Figure 13.

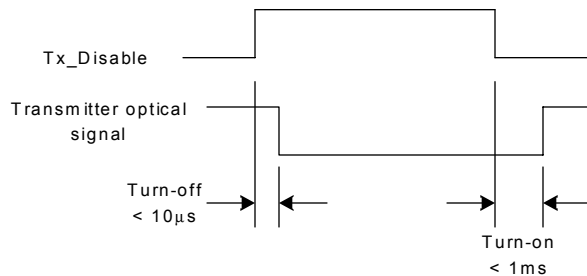
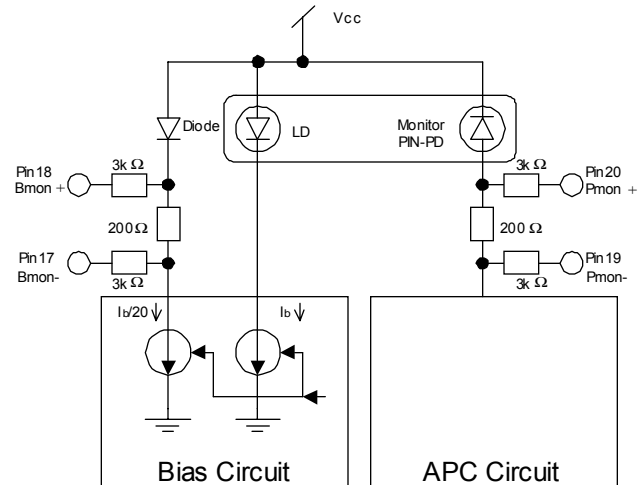


Figure 12. Definition of Turn-on / Turn-off Time



Resistance values are typical.

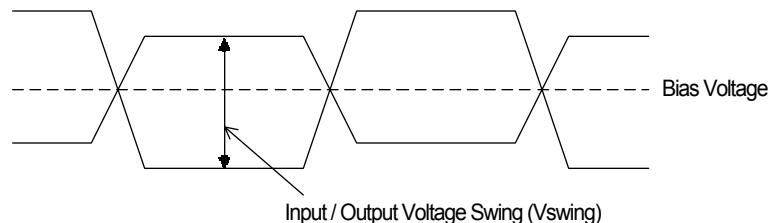
Figure 13. Bmon / Pmon Circuit Detail

6-2. Receiver side

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Supply Voltage	Vcc	3.135	3.30	3.465	V	
Supply Current	Idrx		95	150	mA	
PIN-PD Bias Voltage	VpdR	2.40	3.3	5.25	V	
Differential Output Voltage Swing (RD,RDb)	Vout	0.80		1.90	Vp-p	
SD	High	Vsoh	2.40	Vcc	V	
	Low	Vsol	0.0	0.5	V	
Data Rise / Fall Time	tr / tf		140 / 120		psec	1
SD Assert Time	ta	2.3		100	μsec	2
SD Deassert Time	td	2.3		350	μsec	

Notes

- 20~80%
- 2488.32Mbps, PRBS 2²³-1, NRZ



$$\text{Differential Input / Output Voltage Swing (Vin / Vout)} = 2 \times \text{Vswing}$$

Figure 14. Definition of Differential Input / Output Voltage Swing

7. Optical Interface

(Unless otherwise specified, Vcc = 3.135 to 3.465 V and all operating temperature shall apply.)

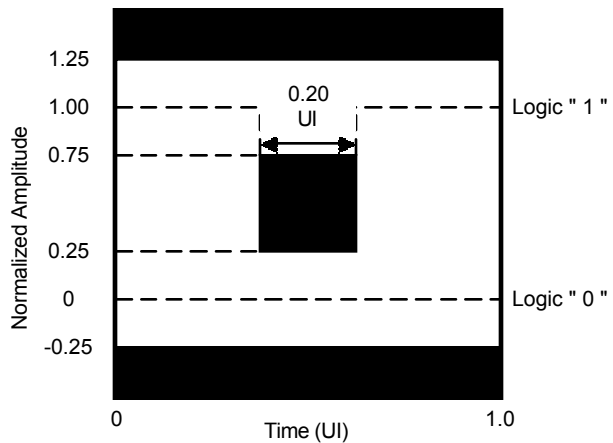
7-1. Transmitter side

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Average Output Power	Po	-10.0		-3.0	dBm	1
Extinction Ratio	Er	8.2			dB	1
Center Wavelength	λ_c	1266		1360	nm	
Spectral Width (RMS)	$\Delta\lambda$			4	nm	
Eye Mask for Optical Output	Compliant with Bellcore GR-253 CORE and ITU G957					
Jitter Generation	Tjpk			0.1	Ulp-p	2
	Tjrms			0.01	Ulrms	

Note 1. Measured at 2488.32Mbps PRBS2²³-1, 50% duty cycle, NRZ, Tdis = L (Tdis = H : Max -45dBm)

2. SONET OC-48c data pattern filled with a 2²³-1 PRBS payload.

Measured with a bandpass filter having a high-pass cutoff frequency of 12kHz and a low-pass cutoff frequency of 20MHz.



Relation between Input Signal and Optical Output Signal

Input Signal		Optical Output Signal
TD	TDb	
High	Low	ON (High)
Low	High	OFF (Low)
High	High	Undefined
Low	Low	Undefined

Figure 15. Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

⚠ Warning

Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

7-2. Receiver side

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Center Wavelength	-	1260		1580	nm	
PD Responsivity		0.7	0.95	1.1	A/W	
Minimum Sensitivity	Pmin		-24.0	-18.0	dBm	1, 2
Overload	Pmax	-3.0			dBm	1, 2
SD Assert Level	Pa		-27.0	-18.0	dBm	2
SD Deassert Level	Pd	-40.0	-29.5		dBm	
SD Hysteresis	Phys	0.5	2.5		dB	
Reflectance	REFr		-14		dB	

Notes

1. BER=10⁻¹⁰

2. Measured at 2488.32Mbps, PRBS 2²³-1, NRZ

8. Relation between Disable Input Voltage and Optical Output Power

Disable Input Voltage	Optical Output Power
"L"(0 ~ 0.8V)	Enabled
"H"(2.0V ~ Vcc)	Disabled (<-45dBm)

*Note : Enabled for no Disable input (Pin 13 open)

9. Recommended Information

9-1. Interface Circuit

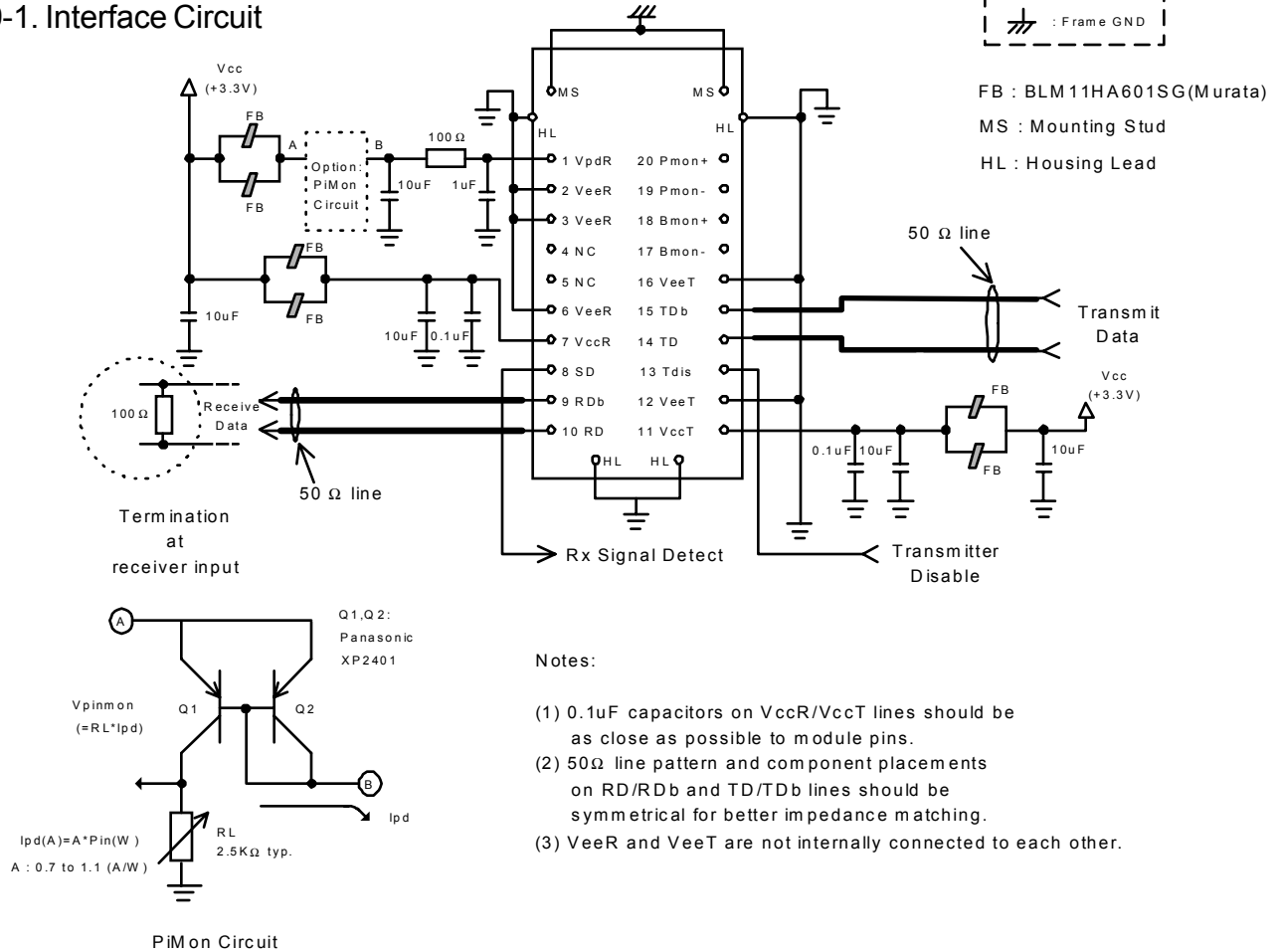


Figure 16. Recommended Interface Circuit

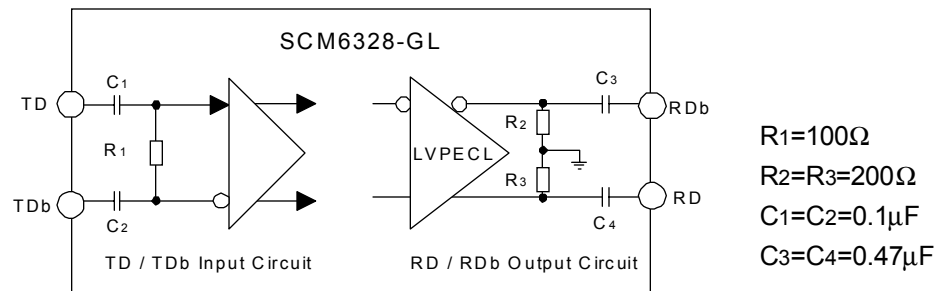
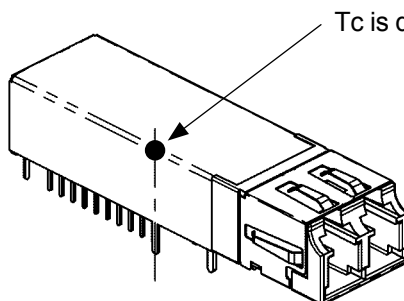


Figure 17. Data Input / Output Circuit

9-2. Tc Definition



Tc is defined as surface temperature of this point.

Forced convection (minimum 1.0m/s) is recommended to ensure Tc be kept below its absolute maximum rating where the ambient temperature is close to the maximum allowed Tc.

10. Reliability Test Program

GR-468-CORE Issue 1, December 1998 Laser Module

HEADING	TEST	REFERENCE	CONDITIONS	SAMPLING		
				LTPD	SS	C
Mechanical Integrity	Mechanical Shock	MIL-STD-883 Method 2002	5 times/axis 1,500G, 0.5ms	20	11	0
	Vibration	MIL-STD-883 Method 2007	Cond. A 20G, 20-2,000 Hz, 4min/cy, 4cy/axis	20	11	0
	Thermal Shock	MIL-STD-883 Method 1011	Delta T=100°C 0°C to 100°C	20	11	0
	Solderability	MIL-STD-883 Method 2003	(steam aging not required)	20	11	0
Endurance	Accel. Aging (High Temp.)	(R)-4-53 Section 5.18	85°C; rated power 1,000 hrs. for pass/fail 2,000, 5,000 hrs. for info.	-	25 10	-
	Low Temp. Storage	-	min. storage T 1,000 hrs. for pass/fail 2,000 hrs. for info.	20	11	0
	Temperature Cycling	Section 5.20	-40°C to +85°C 500 for pass/fail 1,000 for info.	20 -	11 11	0 -
	Damp Heat	MIL-STD-202 Method 103 or IEC-60068-2-3	85°C/85%RH 1,000hrs.	20	11	0
	Cyc. Moist. Res.	Sec. 5.23	-	20	11	0
Special Tests	Internal Moisture	MIL-STD-883 Method 1018	Max. 5,000ppm water vapour	20	11	0
	ESD Threshold	Section 5.22		-	6	-

SS : Sample Size

C : Maximum number of failure allowed to pass the test.

11. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acceptable FDA, complies with 21CFR 1040. 10 and 1040.11. Also this product is a laser class 1 product acceptable IEC 60825-1.

Class 1 Laser Product

⚠ Caution









If this product is used under conditions not recommended in the specification or this product is used with unauthorized revision, classification for laser product safety standard is invalid. Classify the product again at your responsibility and take appropriate actions.

12. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed. The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.

 Warning	
	Be sure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire.
	Do not put this product or components of this product into your mouth. This product contains material harmful to health.

 Caution	
	Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.
	Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

13. Ordering Information

SCM6328 - GL - ☐☐ (LC Duplex Receptacle, Metallized)

Operating Case Temperature

N : Tc=-5~70 °C

W : Tc=-40~85 °C

EMI Shield Finger Option

Z : Without Finger

C : With Type-C Finger

D : With Type-D Finger

14. For More Information

U.S.A.

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http://www.sei.co.jp/Electro-optic/index_e.html

(SCM6328)